



PATENT APPLICATION

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CFR
9-13-01
AJONES

THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Nobuaki HASHIMOTO

Application No.: 09/807,601

Docket No.: 109279

Filed: April 16, 2001

For: INTERCONNECT SUBSTRATE AND METHOD OF MANUFACTURE THEREOF,
ELECTRONIC COMPONENT AND METHOD OF MANUFACTURE
THEREOF, CIRCUIT BOARD AND ELECTRONIC INSTRUMENT

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REQUEST FOR CORRECTION OF PALM RECORDS

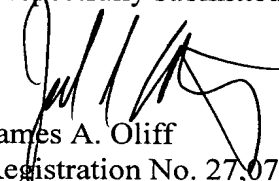
Director of the U.S. Patent and Trademark Office
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Sir:

Attached is a photocopy of the original filing receipt on which errors have been corrected in red. These errors are being brought to the attention of the Patent and Trademark Office so that it may correct its records.

Respectfully submitted,


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Date: July 12, 2001

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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO.	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/807,601	04/16/2001	2811	1282	109279	6	39	4

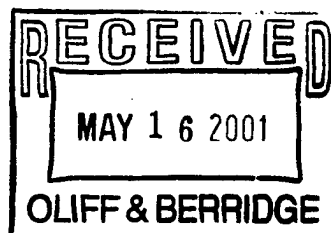
CONFIRMATION NO. 2047

FILING RECEIPT



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Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

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Domestic Priority data as claimed by applicant

THIS APPLICATION IS A 371 OF PCT/JP00/05395 08/11/2000

Foreign Applications

JAPAN 11-232565(P) 08/19/1999

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Projected Publication Date: N/A

Non-Publication Request: No

Early Publication Request: No

Title

Interconnect Substrate and Method of Manufacture Thereof, Electronic Component and Method of Manufacture Thereof, Circuit Board and Electronic Instrument

~~Wiring board, method of manufacturing wiring board, electronic device, method of manufacturing electronic device, circuit board and electronic apparatus~~

Preliminary Class

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